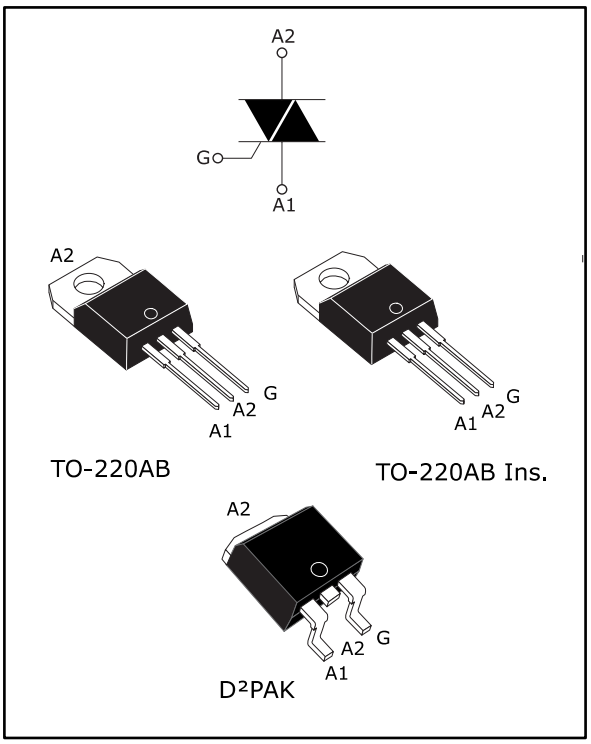
T2035H, T2050H

20 A high temperature Snubberless™ Triacs

Datasheet - production data



Features

- Medium current Triac
- 150 °C max. T_j turn-off commutation
- Low thermal resistance with clip bonding
- Very high 3 quadrant commutation capability
- Packages are RoHS (2002/95/EC) compliant
- UL certified (ref. file E81734)

Applications

Especially designed to operate in high power density or universal motor applications such as vacuum cleaner and washing machine drum motor.

Description

Available in through-hole or surface mount packages, these Triacs series are suitable for general purpose mains power ac switching.

These 20 A Triacs provide a very high switching capability up to junction temperatures of 150 °C.

The heatsink can be reduced, compared to traditional Triacs, according to the high performance at given junction temperatures.

By using an internal ceramic pad, they provide voltage insulation (rated at 2500 V_{RMS}).

Table 1: Device summary

Symbol	Value	Unit
$I_{T(RMS)}$	20	A
V_{DRM}/V_{RRM}	600	V
I_{GT}	35 or 50	mA

1 Characteristics

Table 2: Absolute ratings (limiting values)

Symbol	Parameter			Value	Unit
$I_{T(RMS)}$	RMS on-state current (full sine wave)	D²PAK, TO-220AB	T_C = 128 °C	20	A
		TO-220AB Ins.	T_C = 108 °C		
I_{TSM}	Non repetitive surge peak on-state current (full cycle, T_j initial = 25 °C)	f = 50 Hz	t_p = 20 ms	200	A
		f = 60 Hz	t_p = 16.7 ms	210	
I^2t	I^2t value for fusing		t_p = 10 ms	265	A^2s
dI/dt	Critical rate of rise of on-state current I_G = 2 x I_{GT} , tr ≤ 100 ns	f = 120 Hz	T_j = 150 °C	50	A/µs
V_{DSM} / V_{RSM}	Non repetitive surge peak off-state voltage	t_p = 10 ms	T_j = 25 °C	V_{DRM}/V_{RRM} + 100	V
I_{GM}	Peak forward gate current	t_p = 20 µs	T_j = 150 °C	4	A
$P_{G(AV)}$	Average gate power dissipation		T_j = 150 °C	1	W
T_{stg}	Storage junction temperature range			-40 to +150	°C
T_j	Operating junction temperature range			-40 to +150	°C

Table 3: Electrical characteristics (T_j = 25 °C unless otherwise specified)

Symbol	Test Conditions	Quadrant		Value		Unit
				T2035H	T2050H	
I_{GT}(1)	V_D = 12 V, R_L = 33 Ω	I - II - III	Max.	35	50	mA
V_{GT}			Max.	1.0		
V_{GD}	V_D = V_{DRM}, R_L = 3.3 kΩ	I - II - III	Min.	0.15		V
I_H(2)	I_T = 500 mA		Max.	35	75	mA
I_L	I_G = 1.2 x I_{GT}	I - III	Max.	50	90	mA
		II		80	110	
dV/dt(2)	V_D = 2/3 x V_{DRM}, gate open	T_j = 150 °C	Min.	1000	1500	V/µs
(dI/dt)c(2)	Without snubber	T_j = 150 °C	Min.	27	36	A/ms

Notes:

(1)Minimum I_{GT} is guaranteed at 20% of I_{GT} max.

(2)For both polarities of A2 referenced to A1.

Table 4: Static characteristics

Symbol	Test conditions			Value	Unit
V_T(1)	I_{TM} = 28 A, t_p = 380 µs	T_j = 25 °C	Max.	1.5	V
V_{t0}(1)	Threshold voltage	T_j = 150 °C	Max.	0.80	V
R_d(1)	Dynamic resistance	T_j = 150 °C	Max.	19	mΩ
I_{DRM} / I_{RRM}(2)	V_{DRM} = V_{RRM}	T_j = 25 °C	Max.	5	µA
		T_j = 150 °C	Max.	6.2	mA
	V_D/V_R = 400 V (at peak mains voltage)	T_j = 150 °C	Max.	5.0	
	V_D/V_R = 200 V (at peak mains voltage)	T_j = 150 °C	Max.	4.0	

Notes:

(1)For both polarities of A2 referenced to A1.

(2)t_p = 380 µs

Table 5: Thermal parameters

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	Junction to case (AC)	D²PAK, TO-220AB	1	°C/W
		TO-220AB Ins.	1.9	
$R_{th(j-a)}$	Junction to ambient (S_{cu} = 1 cm²)	D²PAK	45	
	Junction to ambient	TO-220AB, TO-220AB Ins.	60	

1.1 Characteristics (curves)

Figure 1: Maximum power dissipation versus on-state RMS current

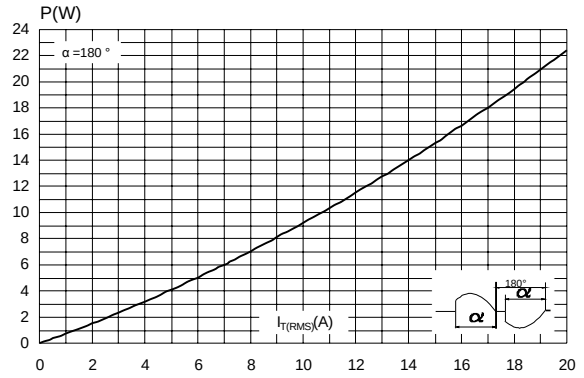


Figure 2: On-state RMS current versus case temperature

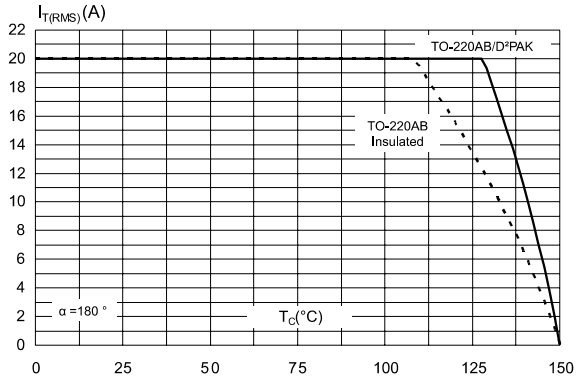


Figure 3: On-state RMS current versus ambient temperature

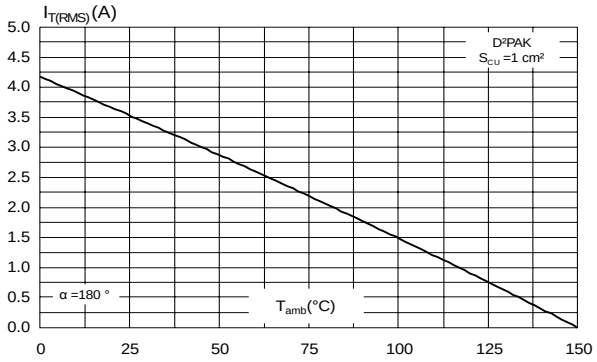


Figure 4: Variation of thermal impedance versus pulse duration

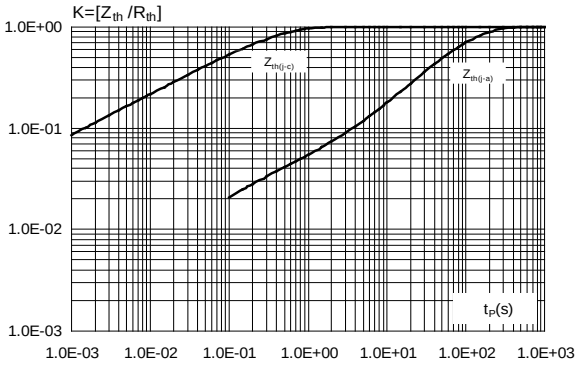


Figure 5: On-state characteristics (maximum values)

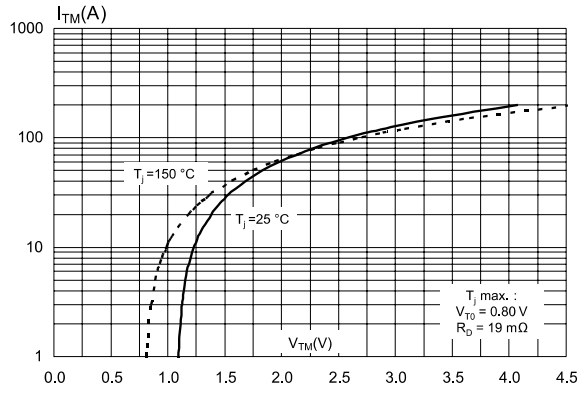


Figure 6: Surge peak on-state current versus number of cycles

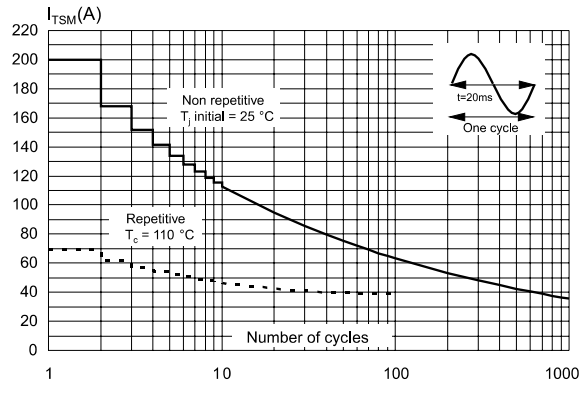


Figure 7: Non-repetitive surge peak on-state current for a sinusoidal pulse

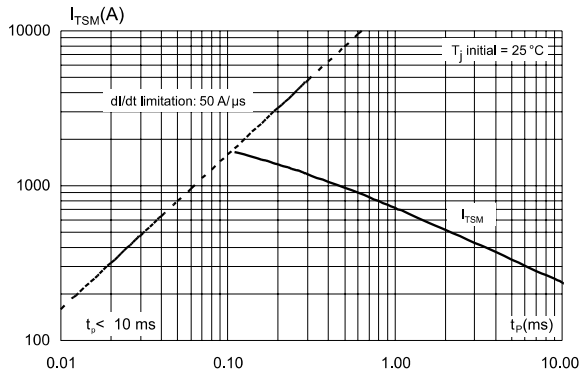


Figure 8: Relative variation of I_{GT}, I_H, I_L vs junction temperature (typical values)

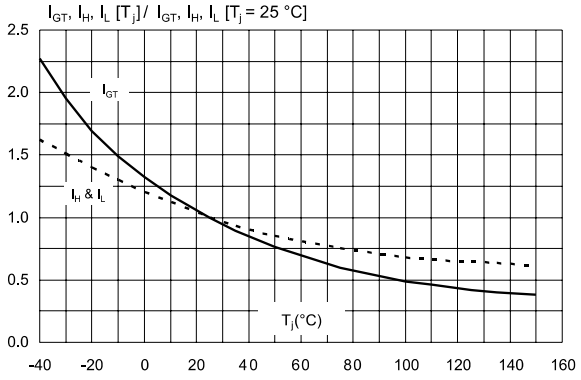


Figure 9: Relative variation of critical rate of decrease of main current (dI/dt)c versus reapplied (dV/dt)c

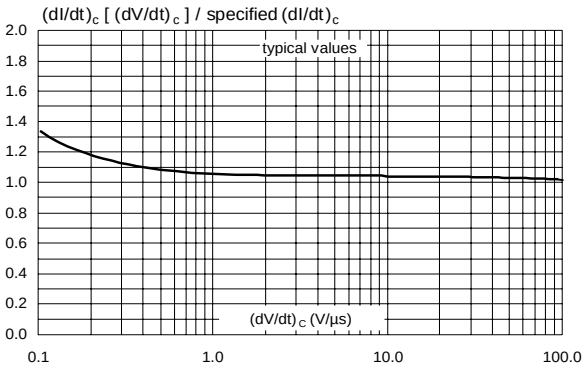


Figure 10: Relative variation of critical rate of decrease of main current versus junction temperature

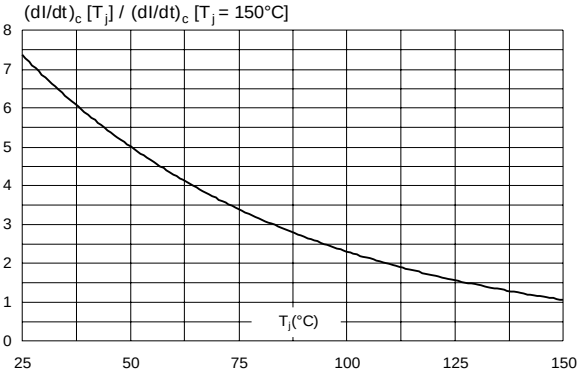


Figure 11: Leakage current versus junction temperature for different values of blocking voltage (typical values)

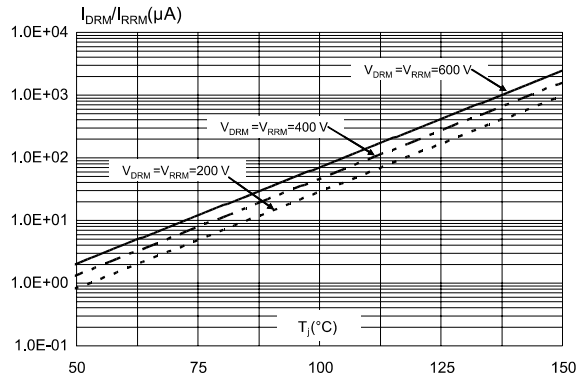


Figure 12: Acceptable repetitive peak off-state voltage versus case to ambient thermal resistance

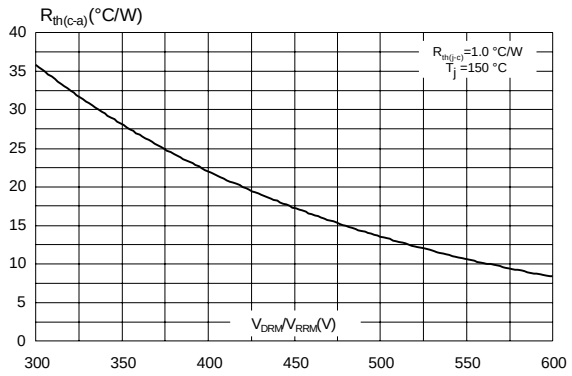
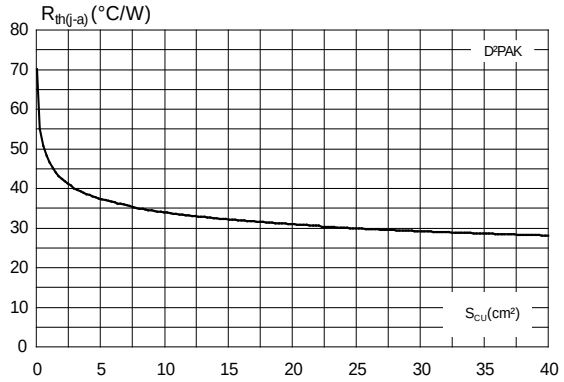


Figure 13: Thermal resistance junction to ambient versus copper surface under tab



2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: ***www.st.com***. ECOPACK® is an ST trademark.

- Epoxy meets UL94, V0
- Lead-free package leads
- Cooling method: by conduction (C)

2.1 D²PAK package information

Figure 14: D²PAK package outline

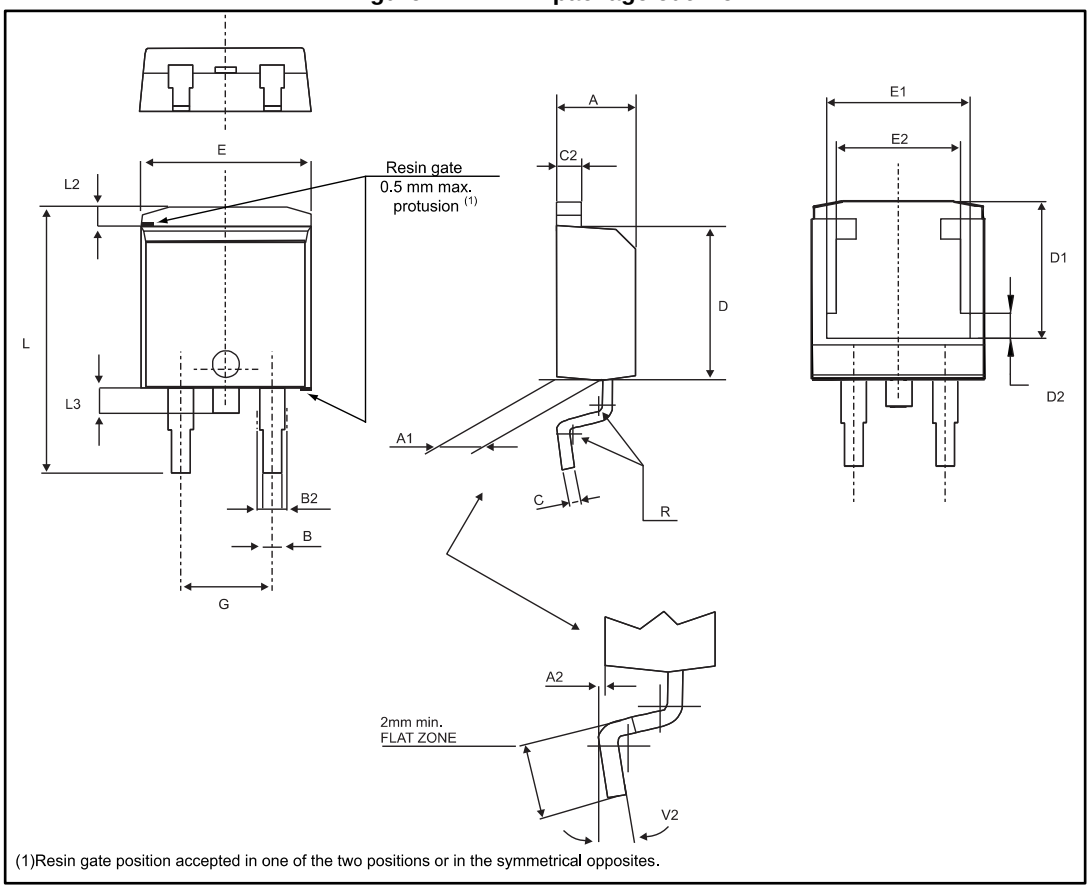


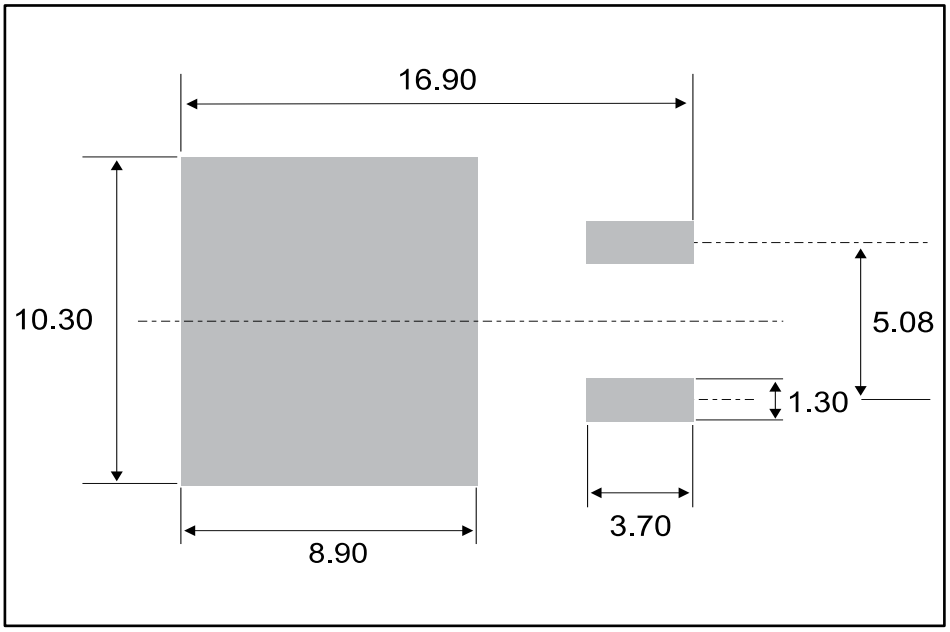
Table 6: D²PAK package mechanical data

Ref.	Dimensions					
	Millimeters			Inches[1]		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.30		4.60	0.1693		0.1811
A1	2.49		2.69	0.0980		0.1059
A2	0.03		0.23	0.0012		0.0091
B	0.70		0.93	0.0276		0.0366
B2	1.25	1.40		0.0492	0.0551	
C	0.45		0.60	0.0177		0.0236
C2	1.21		1.36	0.0476		0.0535
D	8.95		9.35	0.3524		0.3681
D1	7.50		8.00	0.2953		0.3150
D2	1.30		1.70	0.0512		0.0669
E	10.00		10.28	0.3937		0.4047
E1	8.30		8.70	0.3268		0.3425
E2	6.85		7.25	0.2697		0.2854
G	4.88		5.28	0.1921		0.2079
L	15		15.85	0.5906		0.6240
L2	1.27		1.40	0.0500		0.0551
L3	1.40		1.75	0.0551		0.0689
R		0.40			0.0157	
V2	0°		8°	0°		8°

Notes:

[1]Dimensions in inches are given for reference only

Figure 15: D²PAK recommended footprint (dimensions are in mm)



2.2 TO-220AB (NIns. and Ins.) package information

Figure 16: TO-220AB (NIns. and Ins.) package outline

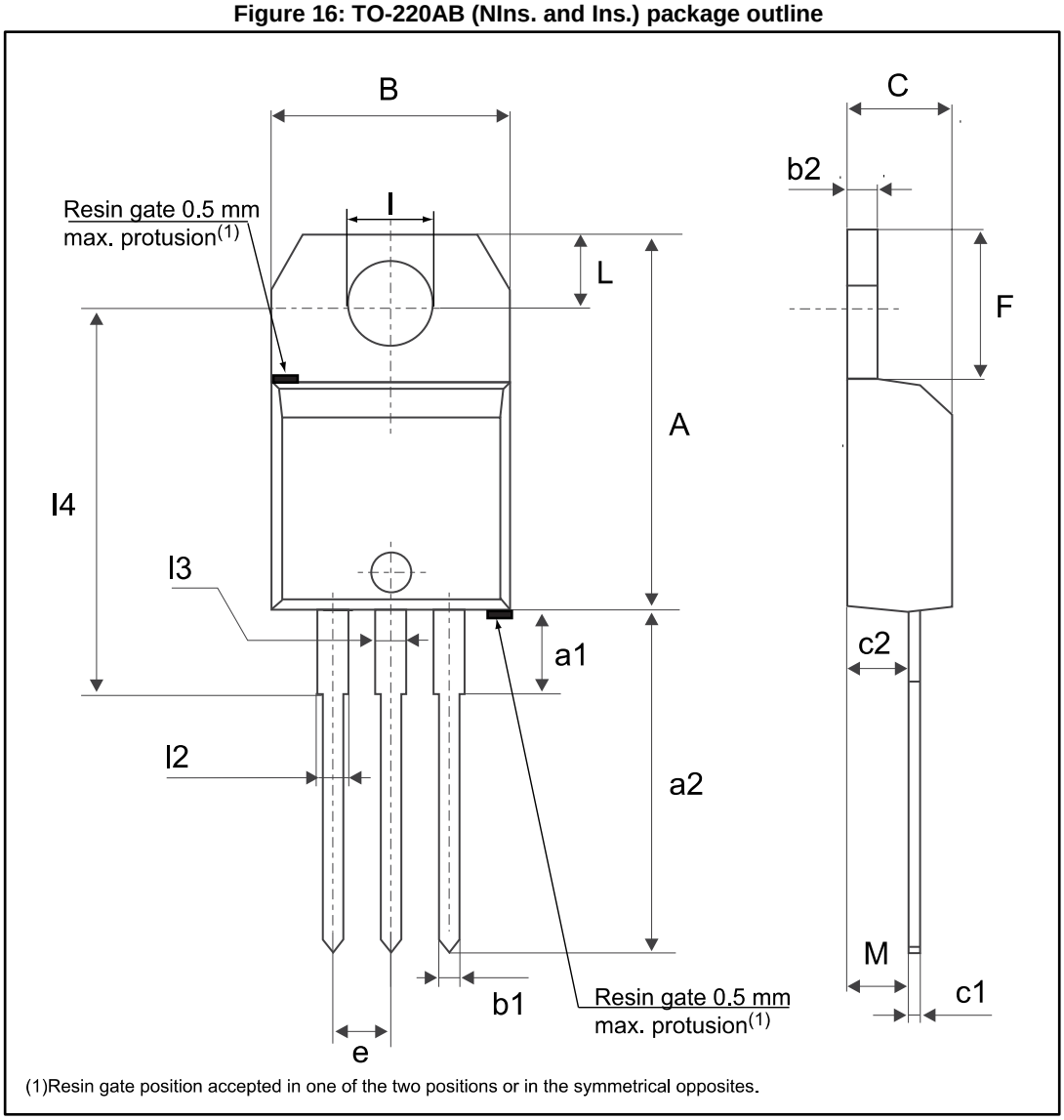


Table 7: TO-220AB (NIns. and Ins.) package mechanical data

Ref.	Dimensions					
	Millimeters			Inches[(1)]		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.20		15.90	0.5984		0.6260
a1		3.75			0.1476	
a2	13.00		14.00	0.5118		0.5512
B	10.00		10.40	0.3937		0.4094
b1	0.61		0.88	0.0240		0.0346
b2	1.23		1.32	0.0484		0.0520
C	4.40		4.60	0.1732		0.1811
c1	0.49		0.70	0.0193		0.0276
c2	2.40		2.72	0.0945		0.1071
e	2.40		2.70	0.0945		0.1063
F	6.20		6.60	0.2441		0.2598
I	3.73		3.88	0.1469		0.1528
L	2.65		2.95	0.1043		0.1161
l2	1.14		1.70	0.0449		0.0669
l3	1.14		1.70	0.0449		0.0669
l4	15.80	16.40	16.80	0.6220	0.6457	0.6614
M		2.6			0.1024	

Notes:

(1)Inch dimensions are for reference only.

3 Ordering information

Figure 17: Ordering information scheme

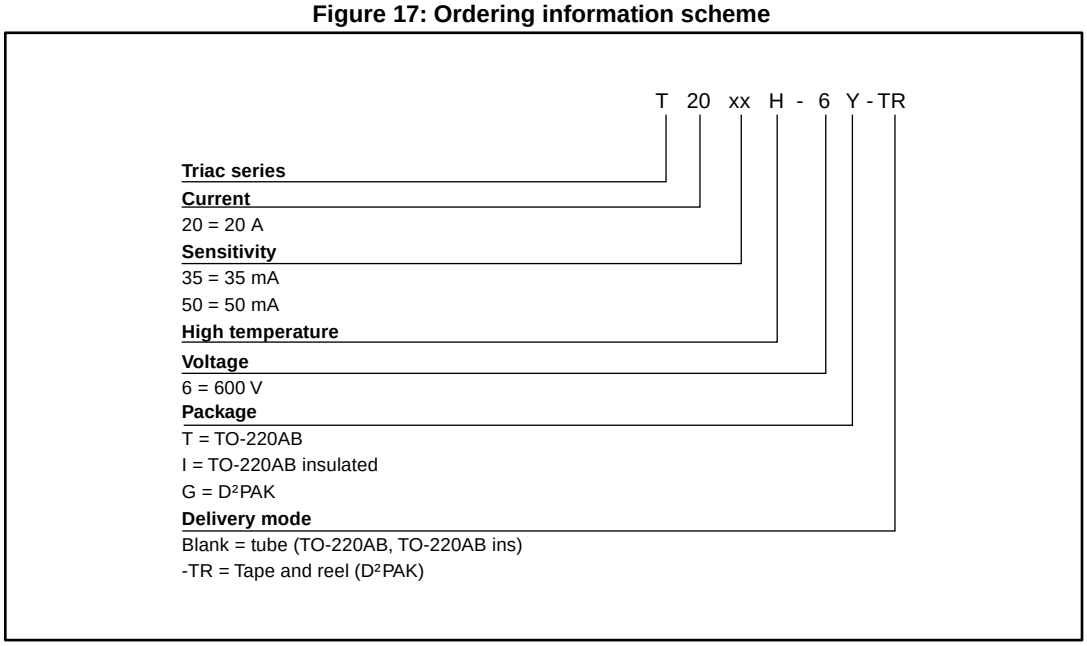


Table 8: Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
T2035H-6G	T2035H-6G	D²PAK	1.5 g	50	Tube
T2035H-6G-TR	T2035H-6G			1000	Tape and reel 13"
T2035H-6I	T2035H-6I	TO-220AB Ins.	2.3 g	50	Tube
T2035H-6T	T2035H-6T	TO-220AB	2.3 g	50	Tube
T2050H-6G	T2050H-6G	D²PAK	1.5 g	50	Tube
T2050H-6G-TR	T2050H-6G			1000	Tape and reel 13"
T2050H-6T	T2050H-6T	TO-220AB	2.3 g	50	Tube

4 Revision history

Table 9: Document revision history

Date	Revision	Changes
31-May-2007	1	First issue.
19-Sep-2011	2	Added TO-220AB Ins and D²PAK packages. Reformatted to current standards.
08-Aug-2011	3	Updated: *Features* and *Description*. Removed order code T20xxH-6G from *Figure 14* and *Table 8.*
05-Jan-2017	4	Updated *Figure 4: "Variation of thermal impedance versus pulse duration"* , *Figure 7: "Non-repetitive surge peak on-state current for a sinusoidal pulse"*, *Section 6.2: "D²PAK package information"*, *Section 6.3: "TO-220AB (NIns. and Ins.) package information"* and *Table 8: "Ordering information"*.

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